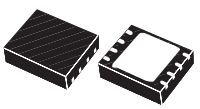
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STCS1

1.5 A max constant current LED driver

Features

- Up to 40 V input voltage
- Less than 0.5 V voltage overhead
- Up to 1.5 A output current
- PWM dimming pin
- Shutdown pin
- LED disconnection diagnostic



DFN8 (3x3 mm)



PowerSO-8

Applications

- Supplying LEDs with constant current for varying input voltages
- Low voltage lighting
- Small appliance LED lighting
- Car LED lights

Description

The STCS1 is a BiCMOS constant current source designed to provide a precise constant current starting from a varying input voltage source. The main target is to replace discrete components solution for driving LEDs in low voltage applications such as 5 V, 12 V or 24 V giving benefits in terms of precision, integration and reliability.

The current is set with external resistor up to 1.5 A with a ± 10 % precision; a dedicated pin allows implementing PWM dimming.

An open-drain pin output provides information on load disconnection condition.

Table 1. Device summary

Order codes	Packages	Packaging
STCS1PUR	DFN8 (3 x 3 mm)	3000 parts per reel
STCS1PHR	PowerSO-8	2500 parts per reel

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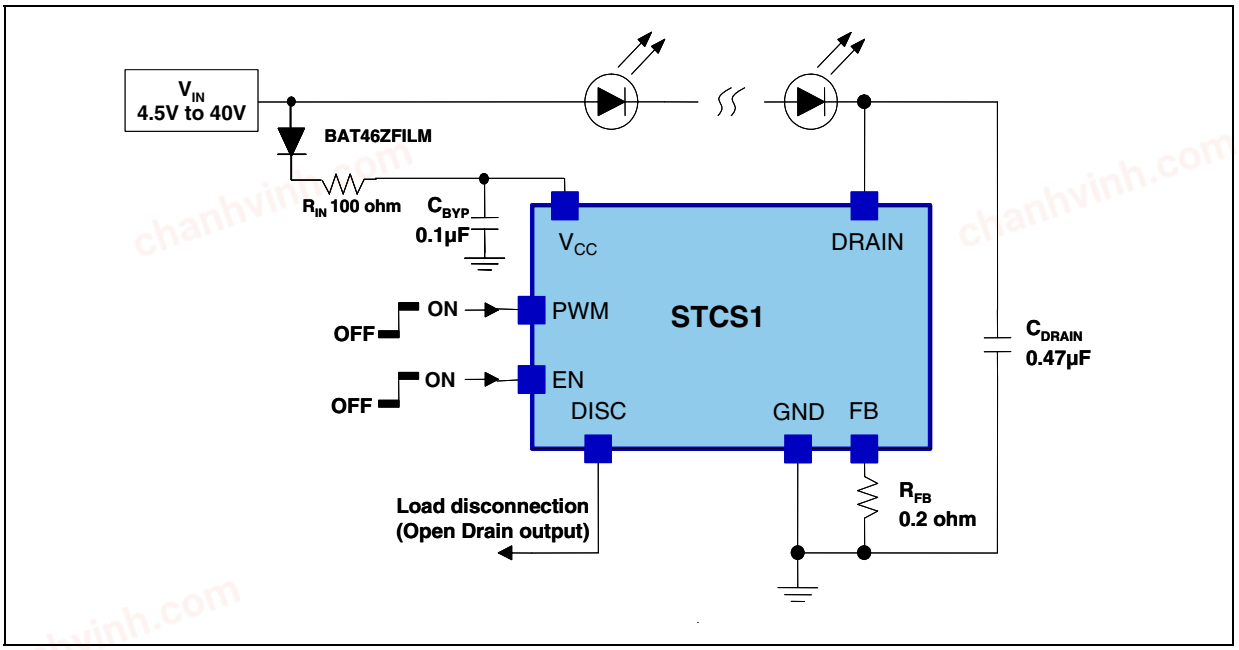
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1 Application diagram

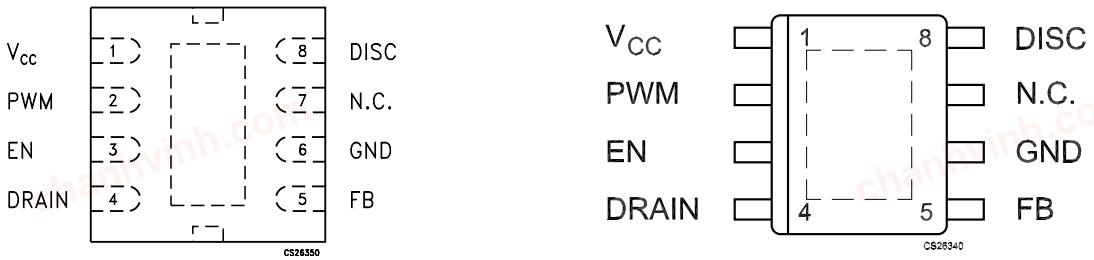
Figure 1. Typical application diagram for 0.5 A LED current



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2 Pin configuration

Figure 2. Pin connections (top view)



DFN8 PowerSO-8

Table 2. Pin description

Pin n°	Symbol	Note
1	V_{CC}	Supply voltage
2	PWM	PWM dimming input
3	EN	Shutdown pin
4	DRAIN	Internal N-MOSFET drain
5	FB	Feedback input. The control loop regulates the current in such a way that the average voltage at the FB input is 100 mV (nominal). The cathode of the LED and a resistor to ground to set the LED current should be connected at this point
6	GND	Ground
7	N.C.	In order to guarantee the device works properly it is mandatory to leave this pin floating
8	DISC	Load disconnection flag (open drain)
	Exp-pad	Internally connected to ground

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3 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	DC supply voltage	-0.3 to +45	V
DRAIN	Drain pin	-0.3 to +45	
PWM, EN, DISC	Logic pins	-0.3 to + V_{CC} + 0.3	V
FB	Configuration pins	-0.3 to + 3.3	V
ESD	Human body model (all pins)	±2	kV
T_J (1)	Junction temperature	-40 to 150	°C
T_{STG}	Storage temperature range	-55 to 150	°C

1. T_J is calculated from the ambient temperature T_A and the power dissipation P_D according the following formula: $T_J = T_A + (P_D \times R_{thJA})$. See *Figure 12* and *Figure 13* for details of max power dissipation for ambient temperatures higher than 25°C.

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied.

Table 4. Thermal data

Symbol	Parameter	DFN8	PowerSO-8	Unit
R_{thJC}	Thermal resistance junction-case	10	12	°C/W
R_{thJA}	Thermal resistance junction-ambient	37.6 (1)	45 (2)	°C/W

1. This value is referred to four-layer PCB, JEDEC standard test board.
2. With two sides, two planes PCB following EIA/JEDEC JESD51-7 standard.

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4 Electrical characteristics

Table 5. Electrical characteristics
(V_{CC} = 12 V; I_O = 100 mA; T_J = -40 °C to 125 °C; V_{DRAIN} = 1 V; C_{DRAIN} = 1 µF; C_{BYP} = 100 nF typical values are at T_A = 25 °C, unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{CC}	Supply voltage range		4.5		40	V
	Output current range		1		1500	mA
I_O	Output current	R_{FB} = 0.2 Ω		500		mA
	Regulation (percentage with respect to V_{CC}=12V)	V_{CC} = 4.5 to 40 V, I_O = 100 mA; V_{DRAIN} = 1 V	-1		+1	%
V_{FB}	Feedback voltage	I_O = 0 to 1.5A	90	100	110	mV
I_{CC}	Quiescent current (Measured on V_{CC} pin)	On Mode		450	750	µA
		Shutdown Mode; V_{CC} = 5 to 12V			1	
		Shutdown Mode; V_{CC} = 12 to 40V			3	
V_{DROP}	Dropout voltage (V_{DRAIN} to GND)	I_O = 100 mA		0.12	0.16	V
		I_O = 1.5 A		0.58	0.9	
$LEAK_{DRAIN}$	Drain leakage current	Shutdown; V_{DRAIN} = 40 V			10	µA
T_D	Delay on PWM signal (see *Figure 3*)	V_{PWM} rising, V_{CC} = 12 V		3		µs
		V_{PWM} falling, V_{CC} = 12 V		1.2		
DISC	Low level voltage	I_{SINK} = 5 mA		0.2	0.5	V
	Leakage current	V_{DISC} = 5 V			1	µA
	Load disconnection threshold (V_{DRAIN}-GND)	DISC Turn-ON		75		mV
		DISC Turn-OFF		110		
Thermal Protection	Shutdown temperature			155		°C
	Hysteresis			25		
Logic inputs (PWM and EN)						
V_L	Input low level				0.4	V
V_H	Input high level		1.2			V
	EN, PWM leakage current	V_{EN} = 5 V; V_{PWM} = 5 V			2	µA
	EN input leakage current	V_{EN} = 40 V			60	
	PWM input leakage current	V_{PWM} = 40 V			120	

Note: All devices 100 % production tested at T_A = 25 °C. Limits over the operating temperature range are guaranteed by design.

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5 Timing

Figure 3. PWM and output current timing

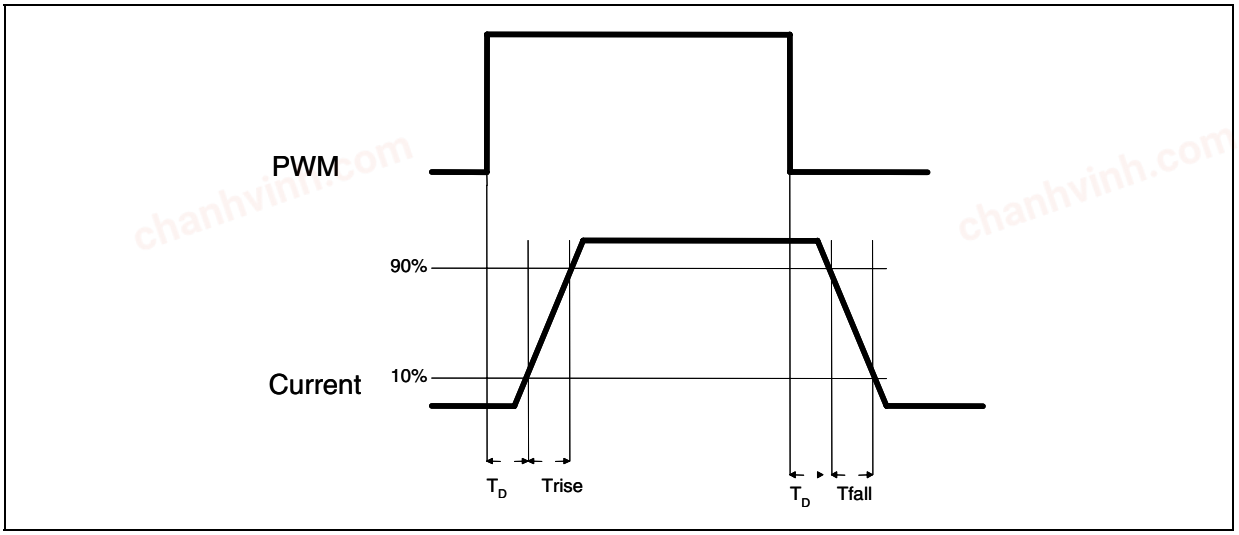
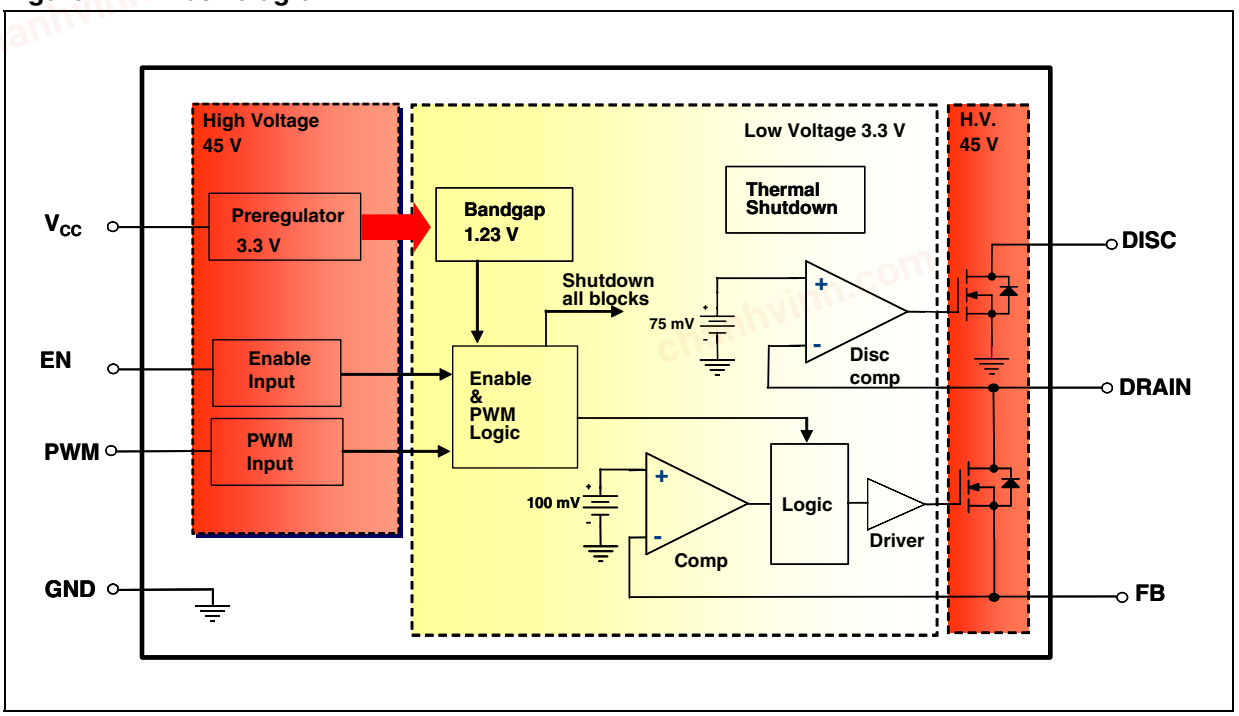


Figure 4. Block diagram



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6 Typical performance characteristics

Figure 5. I_{DRAIN} vs V_{CC}, T_A = 25 °C

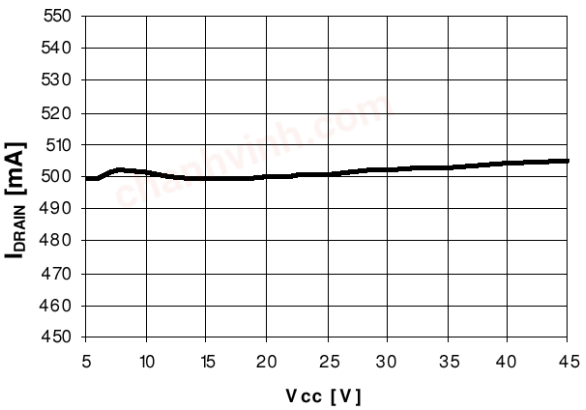


Figure 6. I_{DRAIN} vs R_{SET}

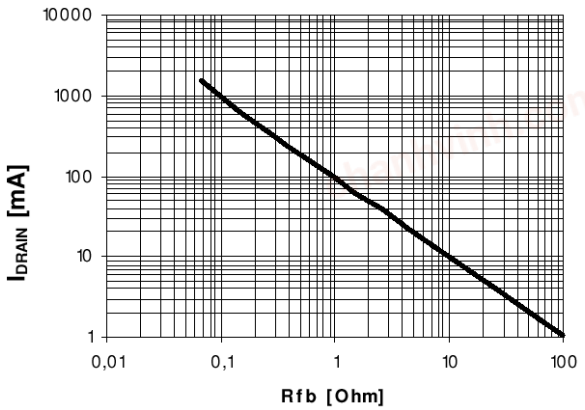


Figure 7. I_{DRAIN} vs temperature

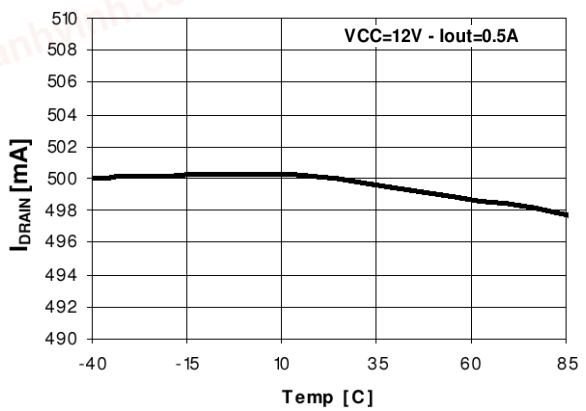


Figure 8. V_{DROP} (including V_{FB}) vs temperature

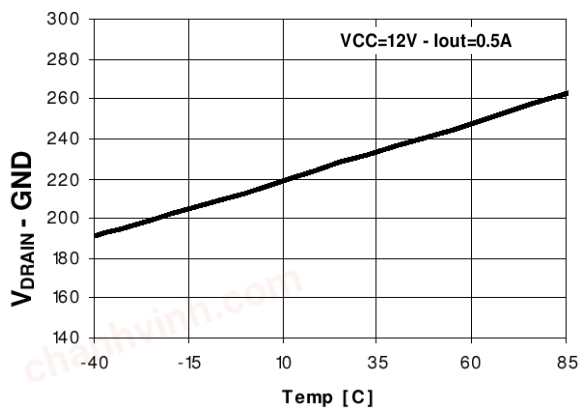


Figure 9. I_{CC} vs temperature

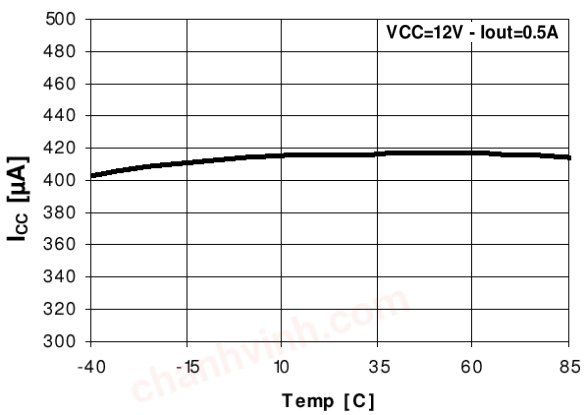
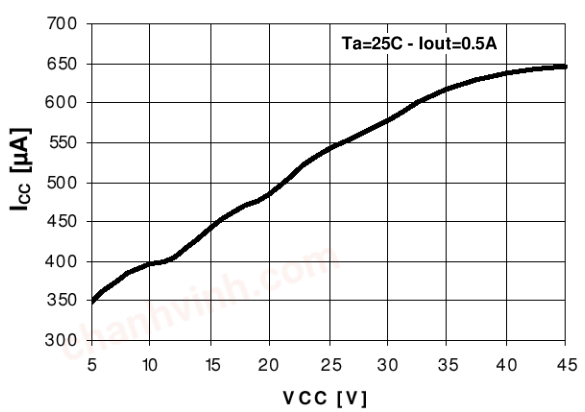


Figure 10. I_{CC} vs V_{CC}



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7 Detail description

The STCS1 is a BiCMOS constant current source designed to provide a precise constant current starting from a varying input voltage source. The main target is to replace discrete components solution for driving LEDs in low voltage applications such as 5 V, 12 V or 24 V giving benefits in terms of precision, integration and reliability.

7.1 Current setting

The current is set with an external sensing resistor connected to the FB pin. The feedback voltage is 100 mV, then a low resistor value can be chosen reducing power dissipation. A value between 1 mA and 1.5 A can be set according to the resistor value, the resulting output current has a tolerance of ± 10 %.

For instance, should one need a 700 mA LEDs current, R_F should be selected according to the following equation:

$R_F = V_{FB} / I_{LEDs} = 100\ mV / 700\ mA = 142\ m\Omega$

7.2 Enable

When the enable pin is low the device completely off thus reducing current consumption to less than 1 µA. When in shutdown mode, the internal main switch is off.

7.3 PWM dimming

The PWM input allows implementing PWM dimming on the LED current; when the PWM input is high the main switch will be on and vice versa. A typical frequency range for the input is from few hertz to 50 kHz. The maximum dimming frequency is limited by the minimum rise/fall time of the current which is around 4 µs each. Above 50 kHz the current waveforms starts assuming a triangular shape.

While the PWM input is switching, the overall circuitry remains on, this is needed in order to implement a short delay time TD (see *Figure 3*).

Since the PWM pin is controlling just the main switch, the overall circuitry is always on and it is able to control the delay time between the PWM input signal and the output current in the range of few µs, this is important to implement synchronization among several light LED sources.

7.4 Diagnostic

When STCS1 is in on mode (EN is high), the device is able to detect disconnection or fail of the LED string monitoring V_{DRAIN} pin. If V_{DRAIN} is lower than 75 mV the DISC pin is pulled low regardless the PWM pin status. This information can be used by the system to inform that some problem happens in the LEDs.

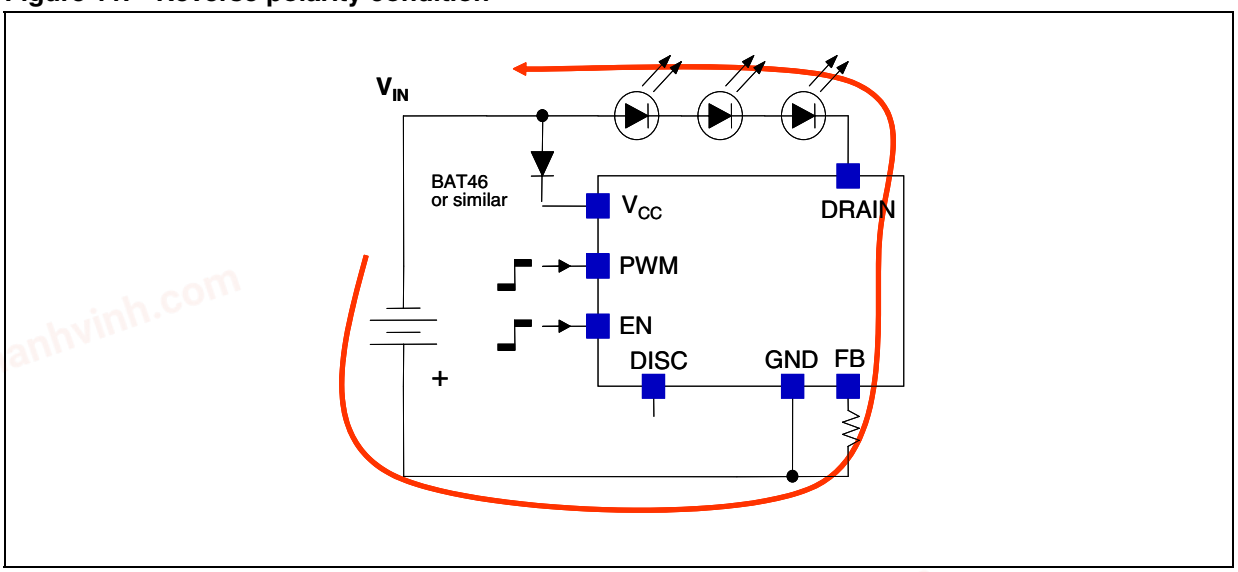
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8 Application information

8.1 Reverse polarity protection

STCS1 must be protected from reverse connection of the supply voltage. Since the current sunk from V_{CC} pin is in the range of 450 µA a small diode connected to V_{CC} is able to protect the chip. Care must be taken for the whole application circuit, especially for the LEDs, in fact, in case a negative voltage is applied between V_{IN} and GND, a negative voltage will be applied to the LED string that must have a total breakdown voltage higher than the negative applied voltage in order to avoid any damage.

Figure 11. Reverse polarity condition



8.2 Thermal considerations

The STCS1 is able to control a LED current up to 1.5 A and able to sustain a voltage on the drain pin up to 40 V. Those operating conditions are however limited by thermal constraints, the thermal resistances shown in the *Table 4: Thermal data* section are the typical ones, in particular R_{thJA} depends on the copper area and the number of layers of the printed circuit board under the pad. DFN8 and PowerSO-8 have an exposed die attach pad which enhances the thermal conductivity enabling high power application.

The power dissipation in the device can be calculated as follow:

$$P_D = (V_{DRAIN} - V_{FB}) \times I_{LED} + (V_{CC} \times I_{CC})$$

basing on this and on the thermal resistance and ambient temperature, the junction temperature can be calculated as:

$$T_J = R_{thJA} \times P_D + T_A$$

A typical application could be:

- Input Voltage: 12 V;
- 3 white LEDs with an typical V_F = 3.6 V;
- LEDs current: 500 mA;

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– Package: DFN8 3x3 mm;
– T_A = 50 °C;

In this case V_{DRAIN} = 12 - 3 x 3.6 = 1.2 V

P_D = (1.2 - 0.1) x 0.5 + 12 x 0.5 x 10^{-3} = 0.55 + 6 x 10^{-3} = 556 mW

The junction temperature will be:

T_J = 37.6 x 0.556 + 50 = 70.9 °C.

The following pictures show the maximum power dissipation according to the ambient temperature for both packages:

Figure 12. Maximum power dissipation vs T_A for DFN8 3x3 mm

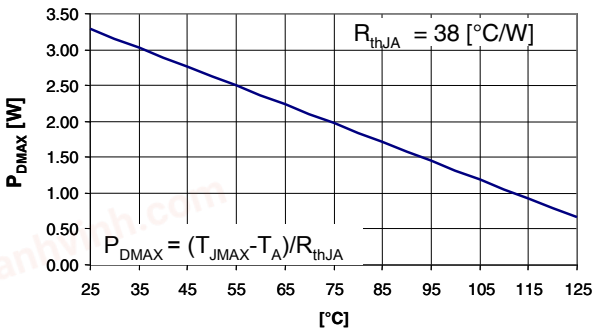
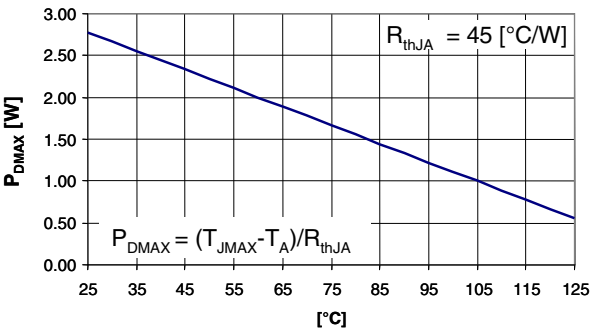


Figure 13. Maximum power dissipation vs T_A for PowerSO-8



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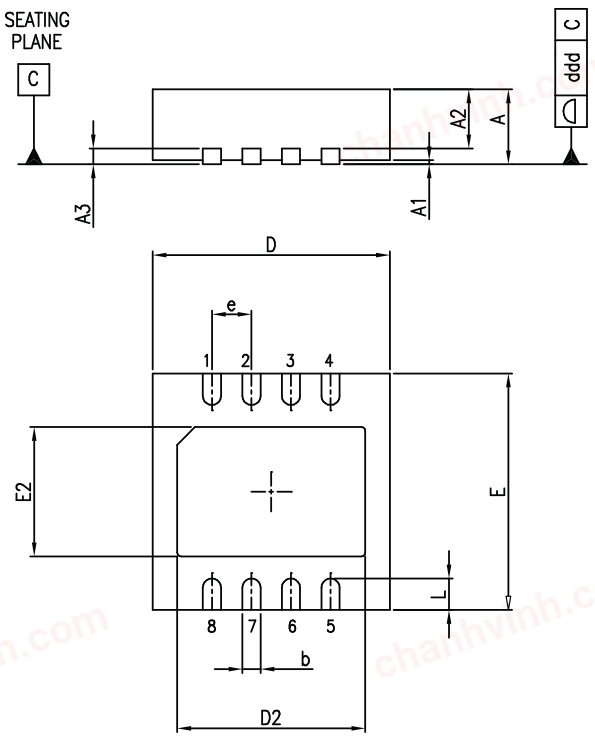
9 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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DFN8 (3x3 mm) mechanical data

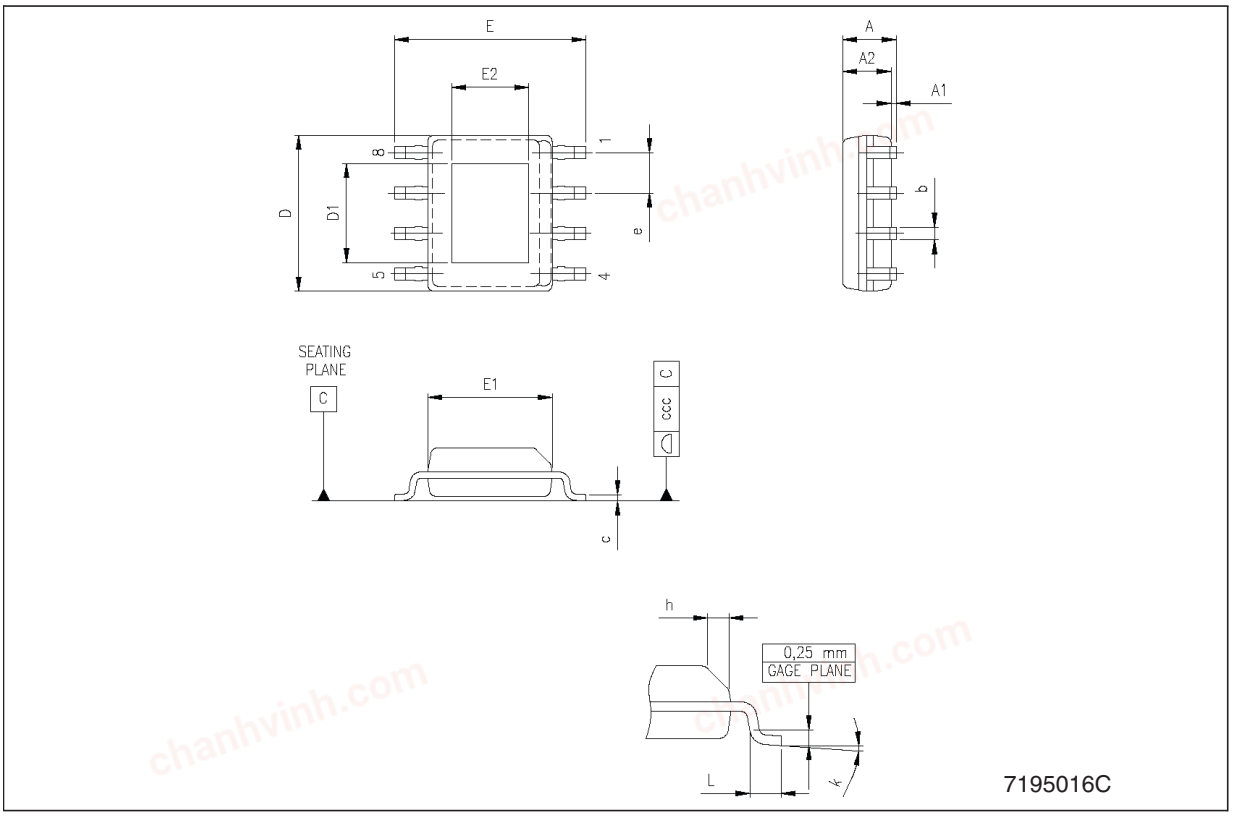
Dim.	mm.			mils.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.80	0.90	1.00	31.5	35.4	39.4
A1		0.02	0.05		0.8	2.0
A2		0.70			27.6	
A3		0.20			7.9	
b	0.18	0.23	0.30	7.1	9.1	11.8
D		3.00			118.1	
D2	2.23	2.38	2.48	87.8	93.7	97.7
E		3.00			118.1	
E2	1.49	1.64	1.74	58.7	64.6	68.5
e		0.50			19.7	
L	0.30	0.40	0.50	11.8	15.7	19.7



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PowerSO-8 mechanical data

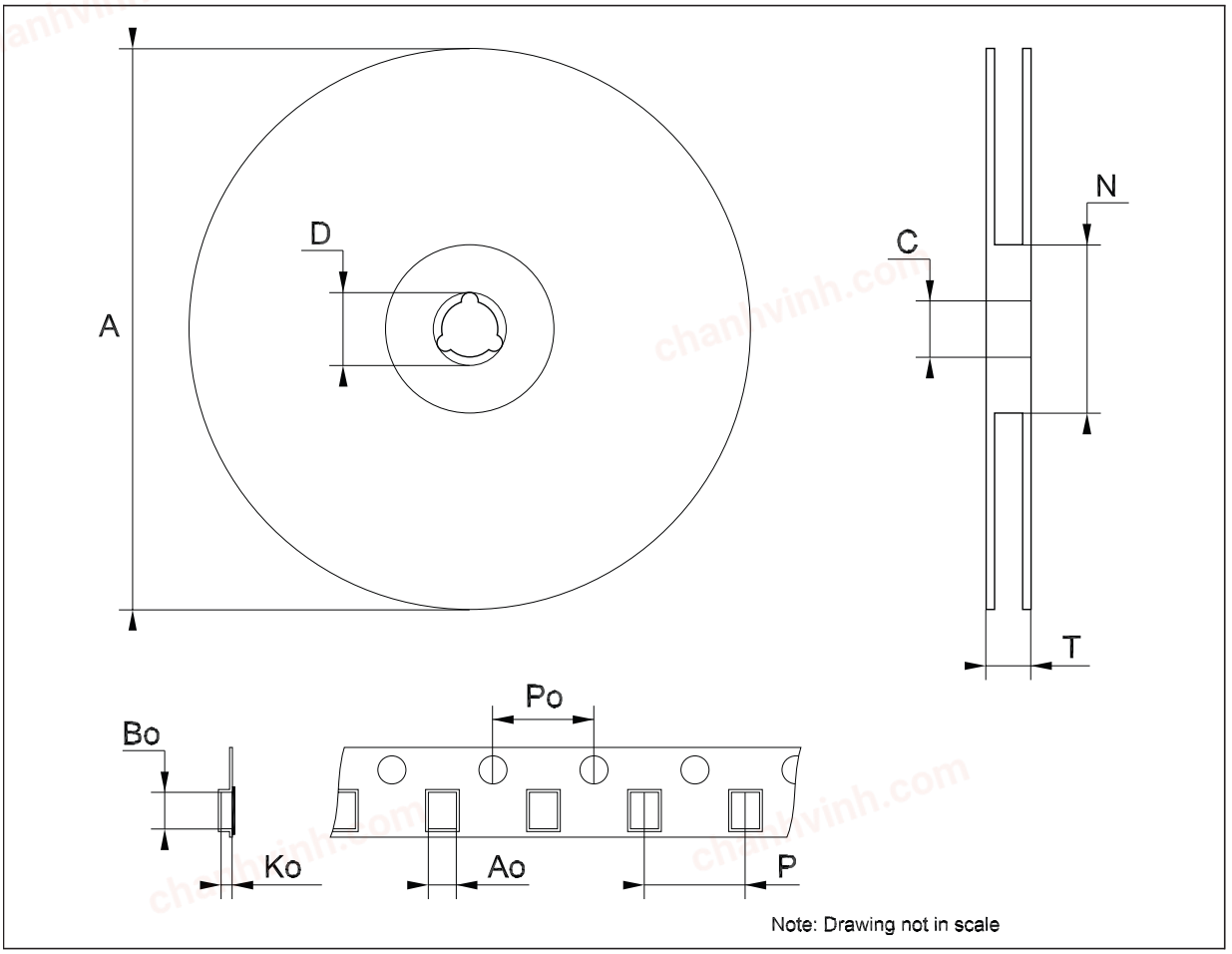
Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.70			0.067
A1	0.00		0.15	0.00		0.006
A2	1.25			0.049		0.142
b	0.31		0.51	0.012		0.020
c	0.17		0.25	0.007		0.010
D	4.80	4.90	5.00	0.189	0193	0.197
D1	2.24	3.10	3.20	0.088	0.122	0.126
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
E2	1.55	2.41	2.51	0.061	0.095	0.099
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	0°		8°	0°		8°
ccc			0.10			0.004



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Tape & reel QFNxx/DFNxx (3x3) mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			180			7.087
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			14.4			0.567
Ao		3.3			0.130	
Bo		3.3			0.130	
Ko		1.1			0.043	
Po		4			0.157	
P		8			0.315	



Note: Drawing not in scale

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10 Revision history

Table 6. Document revision history

Date	Revision	Changes
10-Apr-2007	1	Initial release.
07-May-2007	2	PowerSO-8 mechanical data has been updated and the R_{thJC} for PowerSO-8 value on *Table 4* is changed.
24-May-2007	3	Change value C_{BYP} 0.1µF ==> 1 µF on *Figure 1* typical application.
27-Sep-2007	4	Add R_{IN} on *Figure 1* application diagram.
02-Oct-2007	5	*Figure 1* updated.
15-Feb-2008	6	Modified: *Figure 1 on page 3*, *Figure 4 on page 7*, *Figure 12 on page 11*, *Figure 13 on page 11*.
05-May-2008	7	Modified: *Table 2 on page 4*, pin 7 description.
02-Jul-2008	8	Modified: *Table 5 on page 6*.

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